

## Thermoelectric properties and stability of nanostructured chromium disilicide CrSi 2

M. Khalil, Adrien Moll, M. Godfroy, A. Letrouit-Lebranchu, B. Villeroy, E.

Alleno, Romain Viennois, Mickael Beaudhuin

### ▶ To cite this version:

M. Khalil, Adrien Moll, M. Godfroy, A. Letrouit-Lebranchu, B. Villeroy, et al.. Thermoelectric properties and stability of nanostructured chromium disilicide CrSi 2. Journal of Applied Physics, 2019, 126 (13), pp.135103. 10.1063/1.5117152 . hal-02338762

## HAL Id: hal-02338762 https://hal.umontpellier.fr/hal-02338762v1

Submitted on 30 Oct 2019

**HAL** is a multi-disciplinary open access archive for the deposit and dissemination of scientific research documents, whether they are published or not. The documents may come from teaching and research institutions in France or abroad, or from public or private research centers. L'archive ouverte pluridisciplinaire **HAL**, est destinée au dépôt et à la diffusion de documents scientifiques de niveau recherche, publiés ou non, émanant des établissements d'enseignement et de recherche français ou étrangers, des laboratoires publics ou privés.

Publishing

# Thermoelectric properties and stability of nanostructured chromium disilicide CrSi<sub>2</sub>

Cite as: J. Appl. Phys. **126**, 135103 (2019); https://doi.org/10.1063/1.5117152 Submitted: 02 July 2019 . Accepted: 10 September 2019 . Published Online: 01 October 2019

M. Khalil, A. Moll, M. Godfroy, A. Letrouit-Lebranchu, B. Villeroy, E. Alleno, R. Viennois (10), and M. Beaudhuin (10)

#### COLLECTIONS

Paper published as part of the special topic on Advanced Thermoelectrics Note: This paper is part of the special topic on Advanced Thermoelectrics.



#### ARTICLES YOU MAY BE INTERESTED IN

Dynamic behavior of helium bubbles at high temperature in Si studied by in situ TEM, STEM-EELS, and TDS Journal of Applied Physics **126**, 135104 (2019); https://doi.org/10.1063/1.5118684

Ferroelectric ordering and energy storage capacity in lead-free Ba(Zr<sub>0.2</sub>Ti<sub>0.8</sub>)O<sub>3</sub> nanoscale film capacitors fabricated using pulsed laser deposition technique Journal of Applied Physics **126**, 134101 (2019); https://doi.org/10.1063/1.5117170

Magnetic and cryogenic magnetocaloric properties of NaGdF<sub>4</sub> nanocrystals Journal of Applied Physics **126**, 135101 (2019); https://doi.org/10.1063/1.5114993





## Thermoelectric properties and stability of nanostructured chromium disilicide CrSi<sub>2</sub>

Cite as: J. Appl. Phys. **126**, 135103 (2019); doi: 10.1063/1.5117152 Submitted: 2 July 2019 · Accepted: 10 September 2019 · Published Online: 1 October 2019



#### M. Khalil,<sup>1</sup> A. Moll,<sup>1</sup> M. Godfroy,<sup>1</sup> A. Letrouit-Lebranchu,<sup>1</sup> B. Villeroy,<sup>2</sup> E. Alleno,<sup>2</sup> R. Viennois,<sup>1</sup> 🕞 and M. Beaudhuin<sup>1,a)</sup> 🕞

#### AFFILIATIONS

<sup>1</sup>ICGM, University of Montpellier, CNRS, ENSCM, Montpellier 34095, France <sup>2</sup>ICMPE-CMTR, CNRS UMR 7182, 2-8, rue H. Dunant, Thiais 94320, France

Note: This paper is part of the special topic on Advanced Thermoelectrics. <sup>a)</sup>Author to whom correspondence should be addressed: mickael.beaudhuin@umontpellier.fr

#### ABSTRACT

 $CrSi_2$  alloy presents a strong interest for thermoelectric applications; however, its thermal conductivity is still too high and limits strongly its figure of merit. By combining experiment and modeling, we show that the nanostructuring of  $CrSi_2$  leads to a strong decrease in the thermal conductivity without affecting much the electronic transport properties. The thermal conductivity of nanostructured  $CrSi_2$  (~45 nm) has also been determined as a function of the density. We predict that it would be about 5.5 W/mK at RT for a 100% dense sample, i.e., twice smaller than in bulk samples. We also give for the first time, a prediction of the effect of alloying on the thermal conductivity using the Callaway-Klemens model. To consider final applications, it is necessary to also investigate the thermal stability of nanostructured  $CrSi_2$ , even if it remains limited, happens above 1073 K and will deserve further attention.

Published under license by AIP Publishing. https://doi.org/10.1063/1.5117152

#### I. INTRODUCTION

The interest in renewable energies to sustain economic growth and environmental concerns has increased dramatically these last few decades. Among renewable energies, thermoelectric materials, which allow one to convert heat into electricity, without moving part, can participate in this effort. Their thermoelectric performances are characterized by their dimensionless figure of merit ZT, such as

$$ZT = \frac{S^2\sigma}{\kappa}T,$$

with *S* being the Seebeck coefficient (V K<sup>-1</sup>), *T* being the absolute temperature (Kelvin),  $\sigma$  being the electrical conductivity (S m<sup>-1</sup>), and  $\kappa$  being the thermal conductivity (W m<sup>-1</sup> K<sup>-1</sup>).

There are different ways to improve the figure of merit, either by increasing  $S^2\sigma$  (also known as the power factor PF) or by decreasing  $\kappa$ .

In this work, we study a semiconducting silicide material that presents a strong interest for thermoelectric applications, namely, CrSi<sub>2</sub> (space group P6<sub>2</sub>22).<sup>1</sup> This compound has a high creep

resistance and a good oxidation resistance, which makes it suitable for high temperature applications.<sup>2</sup> It is a highly degenerated *p*-type semiconductor with a narrow indirect bandgap of 0.35 eV.<sup>3,4</sup> It has a relatively high Seebeck coefficient  $(S \sim 100 \,\mu\text{V K}^{-1} \text{ at RT})$ ,<sup>2,5</sup> and a relatively high electrical conductivity ( $\sigma \sim 1000 \text{ S m}^{-1}$ ). Unfortunately, its thermal conductivity is rather high ( $\kappa \sim 10 \text{ W m}^{-1} \text{ K}^{-1}$  at RT),<sup>6</sup> which is detrimental to the thermoelectric performances. It is well known that  $\kappa$  is the sum of two contributions:  $\kappa_e$ , which describes the electronic thermal transport and  $\kappa_{l}$ , which describes the lattice thermal transport. It is not possible to decrease  $\kappa_e$  without decreasing  $\sigma$ . However, as  $\kappa_1$  represents about 93% of the total thermal conductivity  $\kappa$  in pure CrSi<sub>2</sub>,<sup>7,8</sup> there is consequently a strong potential to optimize this material by decreasing  $\kappa_{l}$ . Different research routes can be considered, the first one is the alloying: a distortion of the unit cell can be obtained by substituting an element on the lattice of the compound, which creates strains and mass fluctuations that can scatter phonons; this effect has been efficiently demonstrated in Mg<sub>2</sub>Si<sub>1-x</sub>Sn<sub>x</sub> compounds in Ref. 9. The second one concerns the nanostructuration as it is also strongly favorable to decrease  $\kappa_1$  by creating multiple interfaces that scatter the phonons of various mean free paths.<sup>10,11</sup> We have previously

shown that the thermal conductivity of  $\text{CrSi}_2$  samples can be decreased by a factor of ~10 close to  $1 \text{ Wm}^{-1} \text{ K}^{-1}$  by combining both nanostructuration and porosity.<sup>10</sup> However, the electrical resistivity was increased as well by a factor of ~10. Both effects are related to significant porosity in the studied samples. Recently, we have also shown the importance of reducing the porosity for approaching bulk values of the electrical resistivity, whereas the influence of the porosity on the thermopower was negligible.<sup>12</sup> Nevertheless, a similar study for the porosity dependence of the thermal conductivity of nanostructured  $\text{CrSi}_2$  samples is still lacking, and there is still no study on the impact of the nanostructuration on fully dense  $\text{CrSi}_2$  samples. Up to now, the maximum ZT value of pure  $\text{CrSi}_2$  is 0.25 at 900 K in single crystal along the c-axis.<sup>13,14</sup>

A better understanding of the phonon scattering mechanisms is the first step of a research path to decrease the lattice component of the thermal conductivity of  $CrSi_2$ , an indispensable action before its use in thermoelectric applications.

In this paper, we first present a stability study (300 K-1500 K) of the CrSi<sub>2</sub> nanostructured samples, which is a prerequisite for evaluating the ability of nanostructured samples to be used for long duration-high temperature applications. Then, for the first time, we report moderate temperature measurements (300 K-800 K) of the thermal conductivity for two nanostructured samples with similar nanocrystallite size but with differing porosity and give a prediction for 100% dense nanostructured samples. Finally, we analyze the impact of the porosity, of the small grain size, and of other phonon scattering mechanisms on the lattice thermal conductivity of CrSi<sub>2</sub>.

#### **II. MATERIALS AND METHODS**

#### A. Sample preparations

 $CrSi_2$  was synthesized by arc melting the elements in the stoichiometric ratio under the argon atmosphere using high purity Cr granules (99.995% Alfa Aesar) and Si lumps (99.999% Alfa Aesar). The ingots obtained by this technique were first crushed in an agate mortar and then milled in a Fritsch "Pulverisette 7" planetary micromill in order to decrease the crystallite size. A silicon nitride container (45 ml) and five 15 mm diameter balls were used as the milling media with a ball to powder mass ratio fixed to 10:1. The speed of the supporting disc and of the grinding bowl was 575 rpm and 1150 RPM, respectively, for all the experiments (ball acceleration ~100 m/s<sup>2</sup>). The container was sealed under the argon atmosphere in order to avoid contamination during the milling.

Spark Plasma Sintering (SPS) technique was used to prepare dense pellets using a "Dr. Sinter 515S Syntex" machine. Carbon dies with 8 mm and 10 mm diameter (100 MPa) and a tungsten carbide die with an 8 mm diameter (300 MPa) were used for these experiments along with a graphite foil as a protective layer between the samples and the die. Uniaxial pressure and DC pulses were both delivered by carbon or tungsten carbide punches at both sides.

#### **B. Sample characterization**

The samples were analyzed after each arc melting synthesis, ball milling, and sintering by using an X-Ray Diffraction apparatus (Philips X'PERT, Cu-K  $\alpha$  radiation 1.5406 Å with an accelerated detector PW3050/60 at 45 kV and 30 mA settings). The Rietveld

refinement with Fullprof software was used for structural analysis of each sample. The crystallite size was determined by using the microstructural analysis method from Fullprof software.<sup>15</sup> The chemical homogeneity and composition of the samples were checked using an Energy Dispersive Analyser of X-Ray (EDX) Hitachi S4800 mounted on a Hitachi S2600N scanning electron microscope. Samples porosity was determined by measuring both the mass and the volume of the pellet and by comparing it to the theoretical density obtained by the Rietveld refinement. The stability of nanostructured  $CrSi_2$  was investigated using X-Ray Diffraction from 300 K to 1273 K on a Ta hot-plate under vacuum with 2 h dwell time for the analysis. Powders, dispersed on carbon films, were analyzed on a JEOL 2200 High Resolution Transmission Electron Microscope (HRTEM) at 200 kV, equipped with a CCD camera (GATAN USC) with  $4092 \times 4092$  pixel<sup>2</sup>.

The thermal conductivity  $\kappa$  was derived from the thermal diffusivity  $\alpha$  measured by a laser flash method using a Netzsch LFA 427 system, the specific heat  $C_p$  from the data of Chen *et al.*,<sup>16</sup> and the theoretical density *d* using the relationship  $\kappa = \alpha \cdot C_p \cdot d$ . The uncertainty on the measurement for the thermal conductivity is 10%.<sup>17</sup> The density of the bulk samples was determined by measuring both the mass and the volume of the pellet and by comparing to the theoretical density obtained by the Rietveld refinement. Electrical resistivity was characterized using a homemade apparatus by the Van der Pauw technique (more details are given in the supplementary material). The sample dimensions for electrical resistivity and thermal diffusivity measurements are 8 mm  $\emptyset \times 2$  mm thickness.

#### **III. RESULTS AND DISCUSSION**

#### A. Size of CrSi<sub>2</sub> nanocrystallites

After arc melting and ball milling of the samples, the Rietveld refinement shows that pure CrSi2 is obtained with the unit cell parameters a = 4.433(4) Å and c = 6.366(4) Å, in good agreement with the literature  $(a = 4.442(8) \text{ Å} \text{ and } c = 6.366(8) \text{ Å})^{10}$  (see, for instance, Fig. S1 in the supplementary material). As can be seen in Fig. 1, the analysis of the XRD patterns show that the crystallites size decreases from about 400 nm after 22 min of milling to about  $17 \pm 2$  nm after 24 h of milling. These results are confirmed by the SEM and the bright-field TEM images as shown in Fig. 2 with a typical size ranging from 6 to 11 nm for 4 h milling time. This milling time has been chosen for the whole study. This observation indicates that increasing the ball milling time does not further refine the grain size. One also notices the very strong increase of the internal microstrain from  $\sim 0.45 \pm 0.04\%$ after 22 min of milling up to  $1.05 \pm 0.05\%$  after 24 h of milling. This can be explained by the formation of defects during the highly energetic milling process; a similar behavior has been observed by several groups.<sup>18,19</sup> The SEM images of these samples show that these nanoparticles are aggregated with typical size ranging from 0.5 to  $1.5\,\mu\text{m}$ . The determination of the crystallite size for shorter milling time by TEM suffer from both the difficulty to obtain good enough TEM images due to the large size of the crystallites and because they are in the form of thick aggregates.



FIG. 1. Influence of the milling time on the microstrain and crystallite size of ball-milled CrSi<sub>2</sub> samples.

#### B. Thermal stability of CrSi<sub>2</sub> nanopowders

The stability of the CrSi<sub>2</sub> nanocrystallites under powder form has been investigated as a function of temperature by an in situ XRD technique under vacuum. The powder patterns are displayed in Fig. 3. At 300 K, the pattern is typical of a ball-milled powder with broad peaks. The noticeable background intensity at low angle is in turn characteristic of the occurrence of an(several) amorphous phase(s), formed at the milling stage. By increasing the temperature, a decrease of the full width at half maximum is observed, which means that the crystallites are coarsening. The displacement of the peaks toward lower angles is due to the thermal expansion of the sample. In parallel, one can note that the background is flattened at 973 K, which denotes the crystallization of the amorphous phase (s). Along with the increase of temperature and sample crystallinity, secondary phases are observed above 1073 K: Cr<sub>5</sub>Si<sub>3</sub>, CrSi, and Si were identified. These phases could likely be crystallized from the amorphous phase(s). Since the crystalline phases exhibit the Si concentration of both larger and smaller than CrSi2, either a single amorphous phase decomposes peritectically or several amorphous phases crystallize without changing their composition.



FIG. 2. (a) SEM image of  $CrSi_2$  aggregates in the 4 h ball-milled sample, (b) the bright-field HRTEM image of  $CrSi_2$  crystallite in the same sample.



FIG. 3. In situ X-ray patterns of  $CrSi_2$  nanopowders as a function of temperature.

In Fig. 4, we provide the microstructural analysis of the XRD patterns from Fig. 3. The decrease of the line width corresponds to a small increase in the crystallite size from about 10 nm at 300 K to about 20 nm at 1073 K, followed by a strong increase up to  $\sim$ 120 nm at 1373 K. In parallel and as it could be expected, the microstrain is smoothly released by the annealing. This leads to a decrease of the residual strain from about 0.5 ± 0.05% at 300 K to about 0.05 ± 0.05% at 1373 K. Neither the kinetics of the strain release nor of the crystallite coarsening was studied in this work.

To summarize, we observe that the microstructure of  $CrSi_2$  nanopowders is fairly stable up to 1073 K and that grain coarsening occurs only beyond this temperature.



FIG. 4. Microstructural analysis of the powder XRD patterns displayed in Fig. 3: crystallite size and microstrain, as a function of temperature.

TABLE I. Influence of the sintering conditions on the porosity and on the crystallite size of  $\mbox{CrSi}_2$ 

Temperature (K)	1073	1073	1173
Pressure (MPa)	100	300	100
Density (%)	74	82	94
Crystallite size (nm)	~45	~45	~45

## IV. MICROSTRUCTURE AND THERMAL CONDUCTIVITY IN DENSIFIED CrSi $_2$

#### A. Crystallite size and density of SPS pellets

We have investigated the effect of the temperature and pressure on the sintering of nanostructured  $CrSi_2$  in order to maintain the nanometer size of the crystallites. The optimized SPS conditions are given in Table I. With the condition T = 1073 or 1173 K and P = 100 or 300 MPa, it has been observed that the crystallite size is slightly the same whatever the sintering temperature or pressure is. The highest density (>94%) has been obtained at 1173 K with a pressure of 100 MPa and a crystallite size of ~45 nm. There is consequently an increase of the crystallize size by a factor of about 3 after SPS (the patterns are displayed in Fig. S2 in the supplementary material).

#### B. Thermal conductivity of 74% and 94% CrSi<sub>2</sub>

The thermal conductivity measurements have been performed on samples with 74% and 94% density and similar crystallite size (about 45 nm), the results are shown in Fig. 5. It is observed in Fig. 5(a) that a strong decrease of the total thermal conductivity from ~11 W/mK at 300 K for bulk  $CrSi_2^2$  to, respectively, ~5 and ~3.5 W/mK for nanostructured samples with, respectively, 94% and 74% density. At high temperatures, the thermal conductivity drops slightly from ~6 to, respectively, 4 and 3 W/mK. Whereas the minimum thermal conductivity is obtained at about 770 K for bulk CrSi<sub>2</sub>, for nanostructured ones, the minimum thermal conductivity decreases to lower temperature (~700 K and ~650 K for, respectively, 94% and 74% density samples).

Electronic contribution to the thermal conductivity was calculated based on the electrical resistivity measurement given in Fig. S3 in the supplementary material, using Wiedemann's Franz Law  $\kappa_e = LT/\rho$  with  $L = 2.44 \, 10^{-8} \, \text{W} \, \Omega \, \text{K}^{-2}$ , <sup>13</sup> T being the temperature in Kelvin, and  $\rho$  being the electrical resistivity in Ohm meters. For bulk  $\text{CrSi}_2$  characterized in Ref. 2 and for 94% dense samples,  $\kappa_e$  increases around 700–750 K, for the 74% dense samples,  $\kappa_e$  is negligible and can be attributed to an increase of electron scattering.  $\kappa_e$  weights, respectively, only 2% and 8% of  $\kappa_T$  for 74% and 94% dense samples at 300 K and 7% and 17% at 750 K. When looking to the different contributions to the total thermal conductivity in Fig. 5, one can conclude that the increase of the thermal conductivity at high temperature is due to the electronic contribution, which increases with the temperature.

Our above results explain also why we find a lower thermal conductivity than in hot-pressed nanostructured powders (between 7.7 and 11 W/m K at room temperature)<sup>2,11</sup> whose sintering parameters favored grain coarsening. Indeed, the sintering temperature was much higher in Refs. 2, 11, and 20 than that reported in Table I (1450 K,<sup>2</sup> 1523 K,<sup>11</sup> and 1473 K<sup>20</sup>). Moreover, for hot pressing, the sintering time was intrinsically much longer.

#### C. Theoretical thermal conductivity of 100% dense CrSi<sub>2</sub>

The thermal conductivity of 100% theoretically dense nanostructured  $CrSi_2$  has been calculated by the extrapolation of the 94% and 74% dense sample through the well-known Eucken's



**FIG. 5.** Influence of the porosity on the total thermal conductivity  $\kappa$  and electronic thermal conductivity  $\kappa_{\theta}$  (left) and on the lattice contribution of the thermal conductivity  $\kappa_{\eta}$  (right) of nano-CrSi<sub>2</sub> alloys compared to bulk CrSi<sub>2</sub><sup>2</sup> and simulated 100% density—the 45 nm crystallite size sample.

<b>TABLE II.</b> Fitted A, B, and D parameters for the lattice thermal conductivity of bulk
CrSi2 <sup>2</sup> and nano-CrSi2 (45 nm) with a simulated density of 100% and with experi-
mental samples with a density of 94% and 74%.

	Bulk <sup>2</sup>	100% (sim.)	94% (exp.)	74% (exp.)
$A (10^{-43} \text{ s}^3)$	0.17	4.38	5.71	12.22
$B (10^{-18} \text{ s/K})$	3.64	3.64	3.64	3.64
<i>D</i> (m)	$5.00 \ 10^{-6}$	$4.50 \ 10^{-8}$	$4.50 \ 10^{-8}$	$4.50 \ 10^{-8}$
Microstrain (%)			0.07	0.15
R <sup>2</sup>	0.99	0.97	0.98	0.96

formula given below,

$$\kappa_{porous} = \kappa_{bulk} \frac{2 - 2\phi}{2 + \phi} , \qquad (1)$$

where  $\kappa_{porous}$  and  $\kappa_{bulk}$  are, respectively, the thermal conductivity of porous and dense samples and  $\phi$  stands for the porosity. The thermal conductivity of the 100% theoretically dense sample obtained with this model is quite similar whether using the thermal conductivity obtained for the 94% or for the 74% dense sample. The averaged results are consequently given in Fig. 5 (black dashed lines) and give a prediction of the total thermal conductivity of ~5.5 W/mK (~4.9 W/mK for the lattice thermal conductivity) at RT.

#### D. Callaway-Klemens model

As the present report is the first one reporting detailed thermal variation of the thermal conductivity of CrSi<sub>2</sub> with nanometric grain size, we now describe the impact of the small grain size on the thermal conductivity of CrSi<sub>2</sub> compared to the other phonon scattering mechanisms already present in the bulk samples. To reach this goal, we have performed theoretical fits of the lattice thermal conductivity for our various samples, of the simulated data with 100% dense, and of the bulk sample from Daspgupta's work<sup>2</sup> using

Klemens-Callaway's expression<sup>21–23</sup>

$$\kappa_{l}(T) = \frac{k_{B}}{2\pi^{2}\nu} \left(\frac{k_{B}T}{\hbar}\right)^{3} \int_{0}^{\theta_{D}/T} \frac{x^{4}e^{x}}{\tau_{C}^{-1}(e^{x}-1)^{2}} dx,$$
(2)

where  $x = \hbar \omega / k_B T$  is dimensionless,  $\omega$  is the phonon frequency,  $k_B$  is the Boltzmann constant,  $\hbar$  is the reduced Planck constant,  $\theta_D$  is the Debye temperature,  $\nu$  is the sound velocity, and  $\tau_C$  is the phonon scattering relaxation time. From room to high temperature, the effective phonon scattering relaxation rate  $\tau_C^{-1}$  can be written as<sup>24</sup>

$$\tau_C^{-1} = \tau_M^{-1} + \tau_U^{-1} + \tau_B^{-1}.$$
 (3)

The relaxation rate for the defect/mass-difference scattering is given by the following expression:

$$\tau_M^{-1} = \frac{V_0 \Gamma \omega^4}{4\pi \nu^3},\tag{4}$$

where  $\Gamma$  is the impurity scattering parameter and  $V_0$  is the volume per atom.

The relaxation rate for Umklapp scattering at high temperature (room and above) can be taken as the one given by Klemens as<sup>23</sup>

$$\tau_U^{-1} = \frac{2\gamma^2 k_B T \omega^2}{\mu V_0 \omega_D},\tag{5}$$

where  $\gamma$  is the Gruneisen anharmonicity parameter,  $\mu$  is the shear modulus, and  $\omega_D$  is the Debye frequency. The shear modulus in Eq. (5) is treated as a velocity dependent effective value calculated for a given geometry.

The boundary scattering mechanism is particularly important for low-dimensional nanostructures and its relaxation time is



**FIG. 6.** Lattice thermal conductivity simulated with Klemens-Callaway expressions (2)–(8) at 300 K with  $B = 3.64 \ 10^{-18}$  s/K (left) as a function of A and D and (right) as a function of A with D equal to 10 nm, 45 nm, 5  $\mu$ m, and 1 cm. Fitted parameters reported in Table II (Bulk<sup>2</sup> 100%, 94%, and 74%) are also located on the map (left).

given by

$$\tau_B^{-1} = \frac{\nu}{D},\tag{6}$$

where *D* is the dimension of the system. By combining Eqs. (3)-(6), the phonon scattering relaxation rate can be written as

$$\tau_C^{-1} = \frac{V_0 \Gamma \omega^4}{4\pi \nu^3} + \frac{2\gamma^2 k_B T \omega^2}{\mu V_0 \omega_D} + \frac{\nu}{D}.$$
 (7)

In order to simplify the problem, we introduce the parameters A and B such as

$$\tau_C^{-1} = A\omega^4 + B\omega^2 T + \frac{v}{D}.$$
 (8)

The fitting parameters are listed in Table II. To limit the number of fitted parameters,

• We fixed the prefactor *B* for the phonon-phonon Umklapp scattering for all the samples to the value  $B = 3.64 \quad 10^{-18}$  s/K, after





ARTICLE

fitting the 94% dense sample. Indeed, this parameter is intrinsic to CrSi<sub>2</sub> and should not be affected by the grain size reduction.

• The grain size D is determined experimentally to  $\sim$ 45 nm, as seen above, for the 94% and 74% samples. For the bulk sample, based on the metallurgical process used by Dasgupta et al.<sup>2</sup> and our experience in the synthesis of this alloy, we assume that D is about a micrometer or even larger. For such a dimension, it does not influence much the relaxation rate for the mass-difference scattering parameter A as seen in Fig. 6.

The theoretical model fits the experimental data very well in the temperature range 300 K-600 K (see Table II and Fig. S4 in the supplementary material). A small deviation from the experimental data was observed (not shown here) at higher temperatures, which may be due to the bipolar contribution. We also observe a small effect of the phonon scattering by the point defects in Dasgupta's bulk sample, whereas it increases strongly in the nanostructured samples. This must be due to the ball milling process, which increases significantly the defect density in our samples. Likewise, one notices that the defect/mass-difference scattering parameter's A is smaller for the 94% than for 74% nanostructured samples, in agreement with a smaller internal residual strain which is about 0.07% and 0.15%, respectively. This behavior can be also related to the larger sintering temperature for the 94% dense sample compared to the 74% dense sample. Therefore, t mechanical milling has two effects for decreasing the lattice thermal conductivity: by increasing the grain boundary scattering and by increasing the defect scattering. As shown in Fig. 6 (right), with a grain size of 45 nm, an increase of the defect/mass-difference scattering could lead to a stronger decrease of the thermal conductivity, which is consistent with Eq. (5).

As shown in Fig. 7 and as expected, the boundary scattering mechanism is predominant at low pulsation  $\omega$  for nanostructured samples and negligible for bulk samples. One also notices that the transition from an Umklapp scattering mechanism to point defect scattering mechanism predominance shifts to low frequency when the porosity increases. This behavior is consistent with the increase of defects observed when the porosity increases (see Table II).

#### V. CONCLUSION

In the present study, we show that it is possible to obtain nanostructured CrSi2 samples with about 10 nm grain size after a few hours of ball milling of the bulk CrSi2 sample. We observe that the nanostructured CrSi<sub>2</sub> samples are fairly stable up to 1073 K and that strong grain coarsening occurs beyond this temperature. This means that for avoiding grain coarsening, the temperature range of use must remain under 1073 K. In order to limit the grain coarsening while densifying the powders in the shape of pellets, we have used the SPS technique. We were able to obtain pellet with high density (94%) and keep a small grain size of about 45 nm diameter, which lead to a thermal conductivity of ~5 W/mK. We also predict that the 100% dense sample with the same microstructure would display a thermal conductivity of ~5.5 W/mK, which is twice smaller than in bulk polycrystalline CrSi<sub>2</sub> samples. We have analyzed the impact of the porosity, of the small grain size, and of the other phonon scattering mechanisms on the lattice thermal conductivity of the CrSi2 nanostructured samples. We have

identified a large phonon scattering by the defects in both bulk polycrystalline and nanostructured CrSi2 samples. The large decrease of the lattice thermal conductivity in the CrSi2 nanostructured samples was shown to be due to both phonons scattering by the defects and by the grain boundaries.

#### SUPPLEMENTARY MATERIAL

See the supplementary material for the diffractogram of ballmilled CrSi<sub>2</sub>, of SPS pellets (74% and 94%), the electrical resistivity, and the fitting of the thermal conductivity with the Callaway-Klemens model.

#### ACKNOWLEDGMENTS

The authors wish to thank B. Rebière (IEM, Montpellier) for SEM and the University of Montpellier and the CheMISyst labex (No. ANR-10-LABX-05-01) for their funding.

#### REFERENCES

- <sup>1</sup>M. I. Fedorov and G. N. Isachenko, Jpn. J. Appl. Phys. 54, 07JA05 (2015).
- <sup>2</sup>T. Dasgupta, J. Etourneau, B. Chevalier, S. F. Matar, and A. M. Umarji, J. Appl. Phys. 103, 113516 (2008).
- <sup>3</sup>I. Nishida and T. Sakata, J. Phys. Chem. Solids 39, 499 (1978).
- <sup>4</sup>D. Shinoda, S. Asanabe, and Y. Sasaki, J. Phys. Soc. Jpn. **19**, 269 (1964). <sup>5</sup>I. Nishida, J. Mater. Sci. 7, 1119 (1972).
- <sup>6</sup>T. Dasgupta and A. M. Umarji, J. Alloys Compd. 461, 292 (2008).
- <sup>7</sup>P. Hermet, M. Khalil, R. Viennois, M. Beaudhuin, D. Bourgogne, and D. Ravot, RSC Adv. 5, 19106 (2015).

 ${}^{\mathbf{8}}\!\mathrm{M}.$  Khalil, "Investigation and optimization of semiconducting chromium disilicide based materials for thermoelectric applications," Ph.D. thesis (Univ. Montpellier, Montpellier, 2015).

<sup>9</sup>V. K. Zaitsev, M. I. Fedorov, E. A. Gurieva, I. S. Eremin, P. P. Konstantinov, A. Y. Samunin, and M. V. Vedernikov, Phys. Rev. B 74, 45207 (2006).

10S. Karuppaiah, M. Beaudhuin, and R. Viennois, J. Solid State Chem. 199, 90 (2013)

<sup>11</sup>S. Perumal, S. Gorsse, U. Ail, M. Prakasam, B. Chevalier, and A. M. Umarji, . Mater. Sci. 48, 6018 (2013).

<sup>12</sup>M. Khalil, M. Beaudhuin, B. Villeroy, D. Ravot, and R. Viennois, J. Alloys Compd. 662, 150 (2016).

<sup>13</sup>D. M. Rowe, Thermoelectric Handbook—Macro to Nano (CRC Press, 2006).

<sup>14</sup>B. K. Voronov, L. D. Dudkin, and N. N. Trusova, Sov. Powder Metall. Met. Ceram. 13, 962 (1974).

15J. Rodriguez-Carvajal, Satellite Meeting on Powder Diffraction of the XV Congress IUCr 127, Toulouse, France (Congress International Union of Crystallography, Toulouse, France, 1990).

- <sup>16</sup>H. Chen, Y. Du, and J. C. Schuster, Calphad 33, 211 (2009).
- 17 E. Alleno, D. Berardan, C. Byl, C. Candolfi, R. Daou, R. Decourt, E. Guilmeau, S. Hebert, J. Hejtmanek, B. Lenoir, P. Masschelein, V. Ohorodnichuk, M. Pollet, S. Populoh, D. Ravot, O. Rouleau, and M. Soulier, Rev. Sci. Instrum. 86, 011301 (2015).
- <sup>18</sup>O. M. Lemine, Superlattices Microstruct. **45**, 576 (2009).
- 19 R. Yazdani-rad, S. A. Mirvakili, and M. Zakeri, J. Alloys Compd. 489, 379 (2010). 20 A. Mohamad, Y. Ohishi, Y. Miyazaki, H. Muta, K. Kurosaki, and S. Yamanaka,
- Mater. Trans. 57, 1059 (2016).
- <sup>21</sup>J. Callaway, Phys. Rev. 113, 1046 (1959).
- <sup>22</sup>C. T. Walker and R. O. Pohl, Phys. Rev. 131, 1433 (1963).
- 23 P. G. Klemens, Solid State Physics (Academic Press Inc., NY, 1958), Vol. 7.
- <sup>24</sup>K. S. Dubey and R. H. Misho, Phys. Status Solidi **84**, 69 (1977).
- <sup>25</sup>M. Nakamura, Metall. Mater. Trans. A 25, 331 (1994).